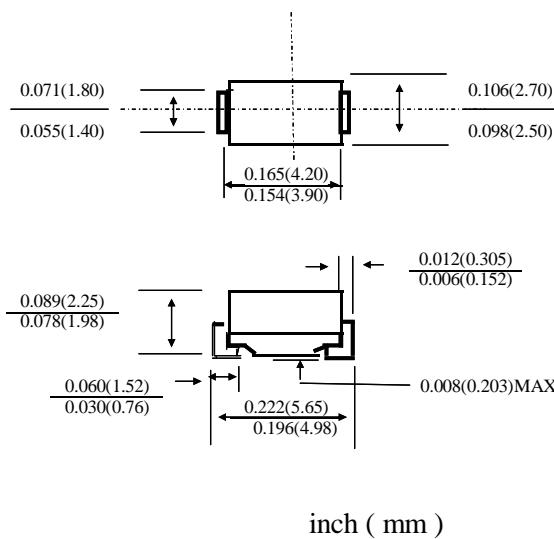


2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIERS

VOLTAGE RANGE: 20 to 100 VOLTS

DO - 214AC(SMA)



inch (mm)

FEATURES

- . For surface mounted applications
- . Metal silicon junction,majority carrier conduction
- . Low power loss,high efficiency
- . Built-in strain relief,ideal for automated placement
- . High forward surge current capability
- . High temperature soldering guaranteed:
250°C/10 seconds at terminals
- . The plastic material carries U/L recognition 94V-O

MECHANICAL DATA

- . Case: JEDEC DO -214AC. molded plastic
- . Terminals: Axial leads. Solderable per MIL - STD - 750 Method 2026
- . Polarity: Color band denotes cathode
- . Weight: 0.003 ounce. 0.093 grams
- . Mounting position: Any

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase. half wave. 60HZ. resistive or inductive load. For capacitive load. derate current by 20%

	SYMBOL	SS22	SS23	SS24	SS25	SS26	SS28	SS210	UNITS				
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	20	30	40	50	60	80	100	V				
Maximum RMS Voltage	V_{RMS}	14	21	28	35	42	56	70	V				
Maximum DC Blocking Voltage	V_{DC}	20	30	40	50	60	80	100	V				
Maximum Average Forward Rectified Current 9.5mm Lead Length. $T_A = 75^\circ C$	$I_{(AV)}$	2.0						A					
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load	I_{FSM}	50.0						A					
Maximum Forward Voltage at 2.0A DC	V_F	0.50		0.70		0.85		V					
Maximum Reverse Current $T_j = 25^\circ C$ at Rated DC Blocking Voltage $T_j = 100^\circ C$	I_R	0.5 15.0						mA					
Typical Junction Capacitance (Note 1)	C_j	150						pF					
Typical Thermal Resistance (Note 2)	R_{QJA}	20						°C/W					
Operating Junction Temperature Range	T_j	— 55 to 125						°C					
Storage Temperature Range	T_{STG}	— 55 to 150						°C					

NOTE: 1. Measured at 1.0MHZ and applied reverse voltage of 4.0V DC

2. P.C.B.mounted with 0.2×0.2 (5.0×5.0mm)copper pad areas

Fig.1-Forward Current Derating Curve

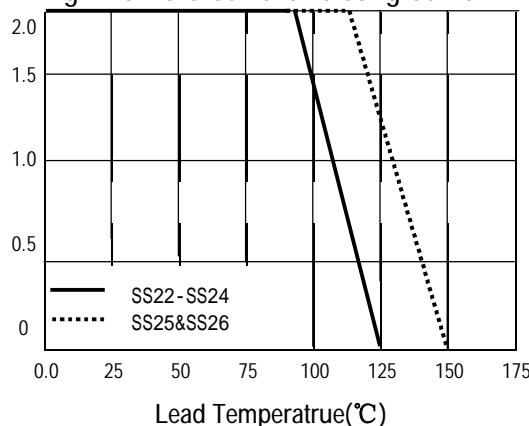


FIG. 3 -- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTIC

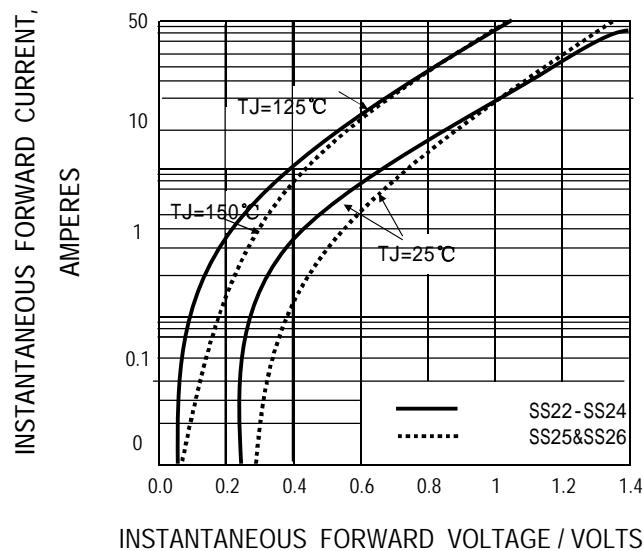


FIG. 5 -- Typical Junction Capacitance

Fig.2-Maximum Non-repetitive Surge Current

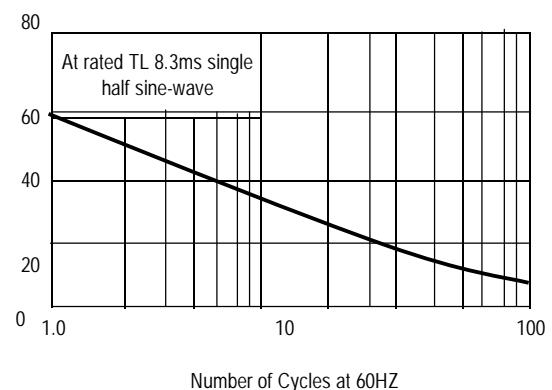


FIG. 4 -- TYPICAL REVERSE CHARACTERISTICS

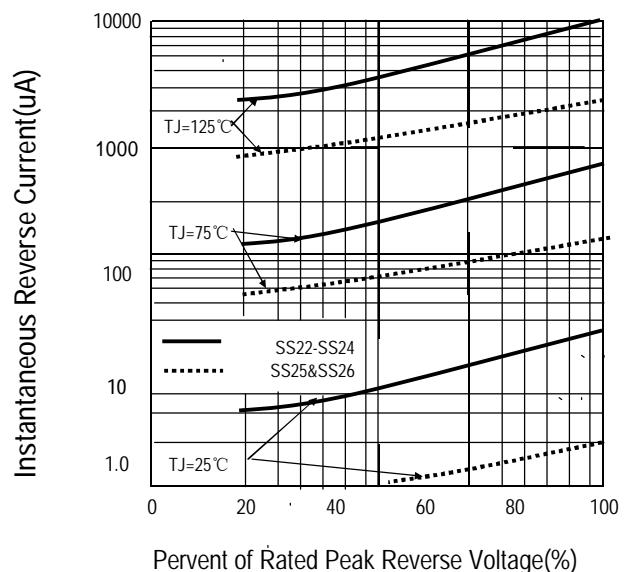


FIG. 6 -- Typical Transient Thermal Impedance

